



SOP-8 30V Dual N Channel Enhancement 双 N 沟道增强型 MOS Field Effect Transistor 场效应管

■ Features 特点

Low on-resistance 低导通电阻

$R_{DS(ON)}=17m\Omega(\text{Type})@V_{GS}=10V$

$R_{DS(ON)}=23m\Omega(\text{Type})@V_{GS}=4.5V$

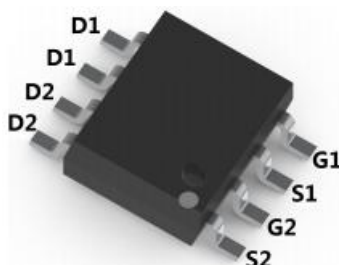
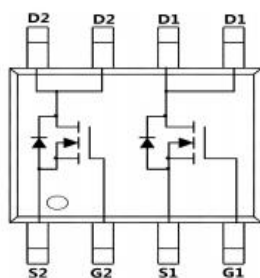
■ Applications 应用

Portable Equipment 桌面设备

Battery Powered System 电池电源系统

Power Management in Note Book 笔记本电源管理

■ Internal Schematic Diagram 内部结构



■ Absolute Maximum Ratings 最大额定值

Characteristic 特性参数	Symbol 符号	Rat 额定值	Unit 单位
Drain-Source Voltage 漏极-源极电压	BV_{DSS}	30	V
Gate- Source Voltage 栅极-源极电压	V_{GS}	± 20	V
Drain Current (continuous)漏极电流-连续	I_D (at $T_A = 25^\circ C$)	8	A
Drain Current (pulsed)漏极电流-脉冲	I_{DM}	40	A
Total Device Dissipation 总耗散功率	$P_D(\text{at } T_A = 25^\circ C)$	1700	mW
Thermal Resistance Junction-Ambient 热阻	$R_{\theta JA}$	73.5	$^\circ C/W$
Junction/Storage Temperature 结温/储存温度	T_J, T_{stg}	-55~150	$^\circ C$



■ Electrical Characteristics 电特性

($T_A=25^{\circ}\text{C}$ unless otherwise noted 如无特殊说明, 温度为 25°C)

Characteristic 特性参数	Symbol 符号	Min 最小值	Typ 典型值	Max 最大值	Unit 单位
Drain-Source Breakdown Voltage 漏极-源极击穿电压($I_D=250\mu\text{A}, V_{GS}=0\text{V}$)	BV_{DSS}	30	—	—	V
Gate Threshold Voltage 栅极开启电压($I_D=250\mu\text{A}, V_{GS}=V_{DS}$)	$V_{GS(th)}$	1	1.5	1.9	V
Zero Gate Voltage Drain Current 零栅压漏极电流($V_{GS}=0\text{V}, V_{DS}=24\text{V}$)	I_{DSS}	—	—	1	μA
Gate Body Leakage 栅极漏电流($V_{GS}=\pm 20\text{V}, V_{DS}=0\text{V}$)	I_{GSS}	—	—	± 100	nA
Static Drain-Source On-State Resistance 静态漏源导通电阻($I_D=8\text{A}, V_{GS}=10\text{V}$) ($I_D=7\text{A}, V_{GS}=4.5\text{V}$)	$R_{DS(ON)}$	—	17.5 23	27 30	$\text{m}\Omega$
Diode Forward Voltage Drop 内附二极管正向压降($I_{SD}=1\text{A}, V_{GS}=0\text{V}$)	V_{SD}	—	—	1	V
Input Capacitance 输入电容 ($V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$)	C_{ISS}	—	580	—	pF
Common Source Output Capacitance 共源输出电容($V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$)	C_{OSS}	—	95	—	pF
Reverse Transfer Capacitance 反馈电容 ($V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$)	C_{RSS}	—	57	—	pF
Total Gate Charge 栅极电荷密度 ($V_{DS}=15\text{V}, I_D=8\text{A}, V_{GS}=4.5\text{V}$)	Q_g	—	6	—	nC
Gate Source Charge 栅源电荷密度 ($V_{DS}=15\text{V}, I_D=8\text{A}, V_{GS}=4.5\text{V}$)	Q_{gs}	—	2	—	nC
Gate Drain Charge 栅漏电荷密度 ($V_{DS}=15\text{V}, I_D=8\text{A}, V_{GS}=4.5\text{V}$)	Q_{gd}	—	2	—	nC
Turn-ON Delay Time 开启延迟时间 ($V_{DS}=15\text{V}, I_D=1\text{A}, R_{GEN}=6\Omega, V_{GS}=10\text{V}$)	$t_{d(on)}$	—	6	—	ns
Turn-ON Rise Time 开启上升时间 ($V_{DS}=15\text{V}, I_D=1\text{A}, R_{GEN}=6\Omega, V_{GS}=10\text{V}$)	t_r	—	12	—	ns
Turn-OFF Delay Time 关断延迟时间 ($V_{DS}=15\text{V}, I_D=1\text{A}, R_{GEN}=6\Omega, V_{GS}=10\text{V}$)	$t_{d(off)}$	—	18	—	ns
Turn-OFF Fall Time 关断下降时间 ($V_{DS}=15\text{V}, I_D=1\text{A}, R_{GEN}=6\Omega, V_{GS}=10\text{V}$)	t_f	—	5	—	ns

Typical Characteristic Curve 典型特性曲线

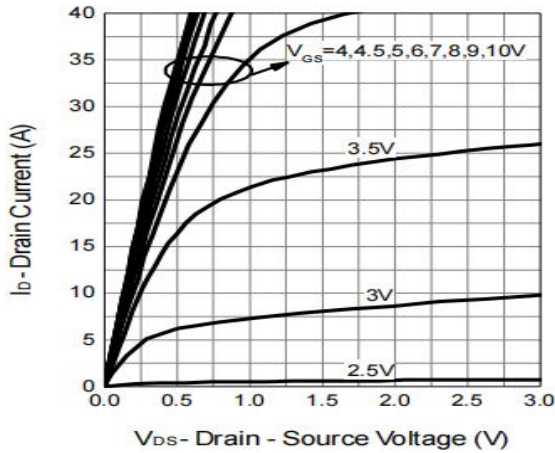


Figure 1: Output Characteristics

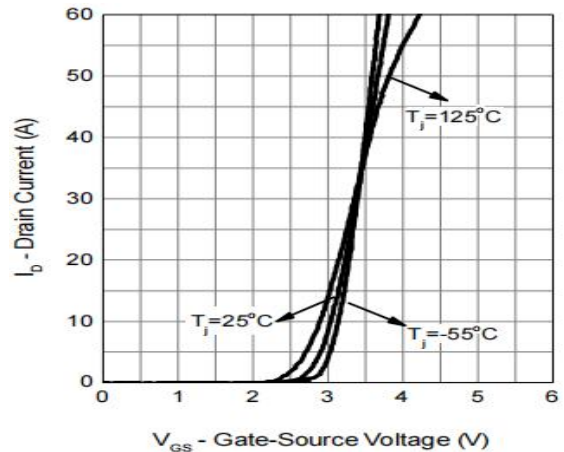


Figure 2: Transfer Characteristics

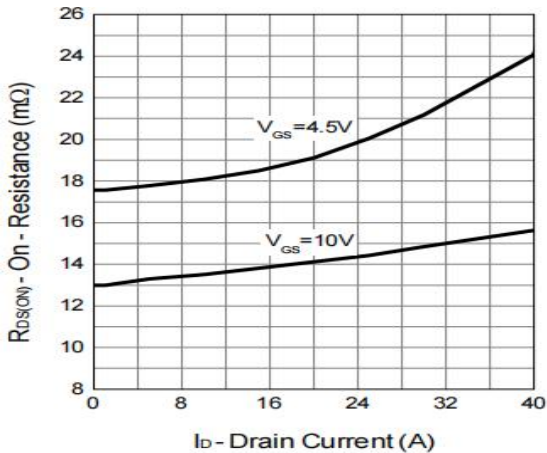


Figure 3: On-Resistance vs. Drain Current

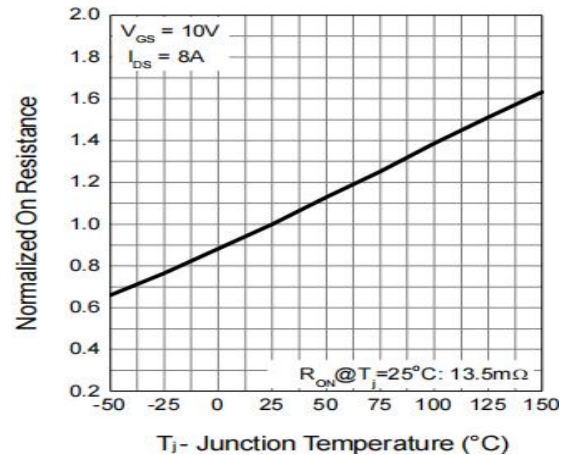


Figure 4: On-Resistance vs. Temperature

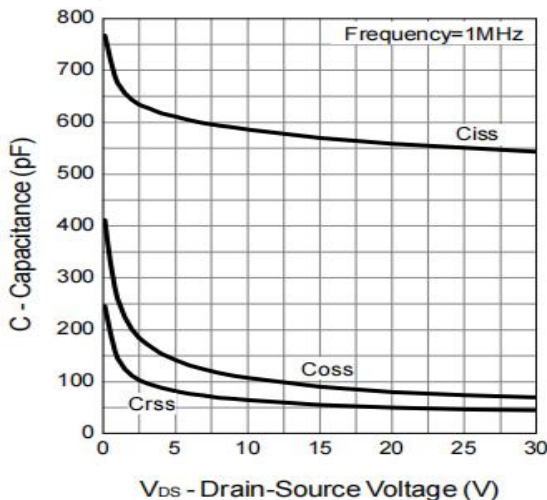


Figure 5: Capacitance Characteristics

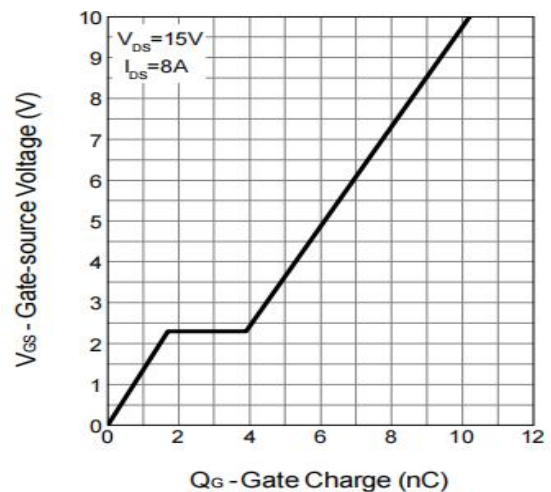


Figure 6: Gate-Charge Characteristics

Typical Characteristic Curve 典型特性曲线

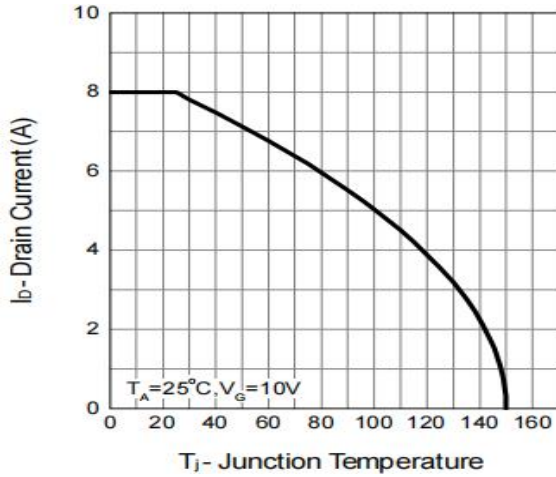


Figure 7: Drain Current vs. Temperature

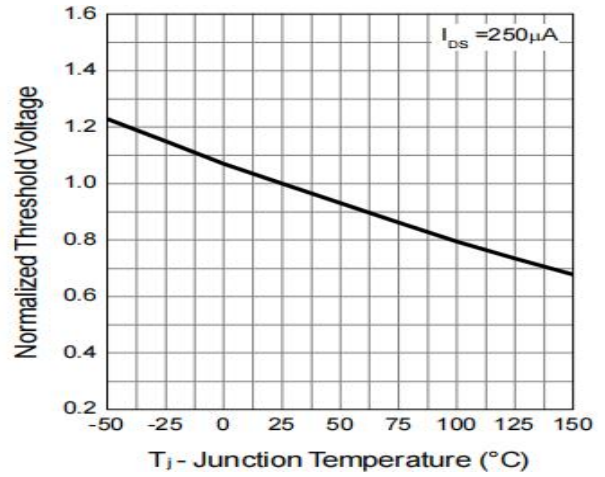


Figure 8: Threshold Voltage vs. Temperature

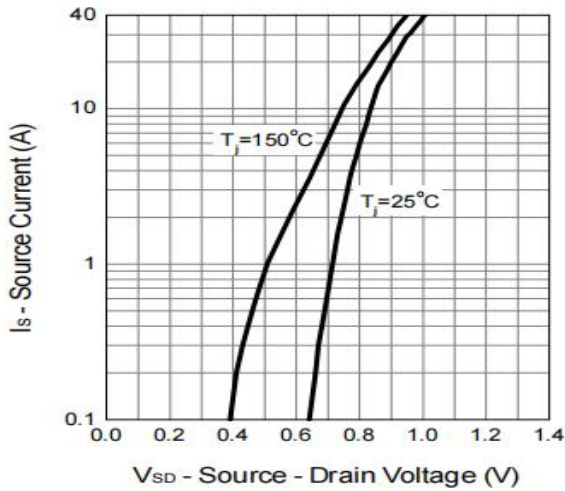


Figure 9: Diode Characteristics

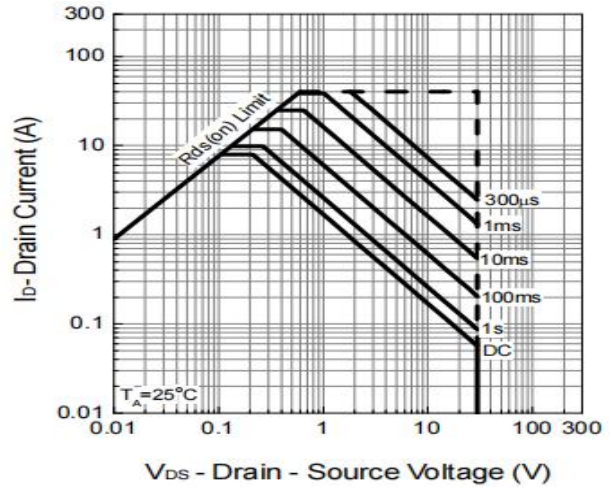


Figure 10: Safe Operating Area

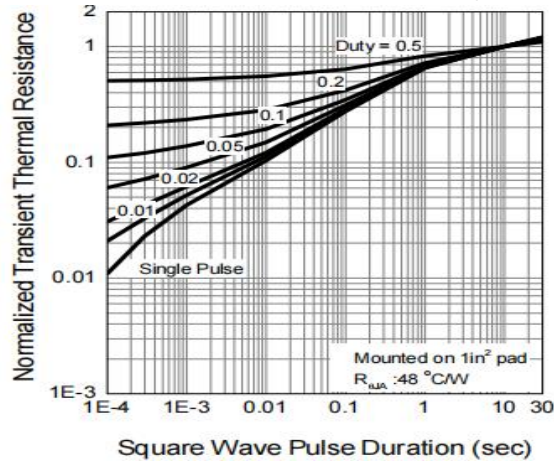
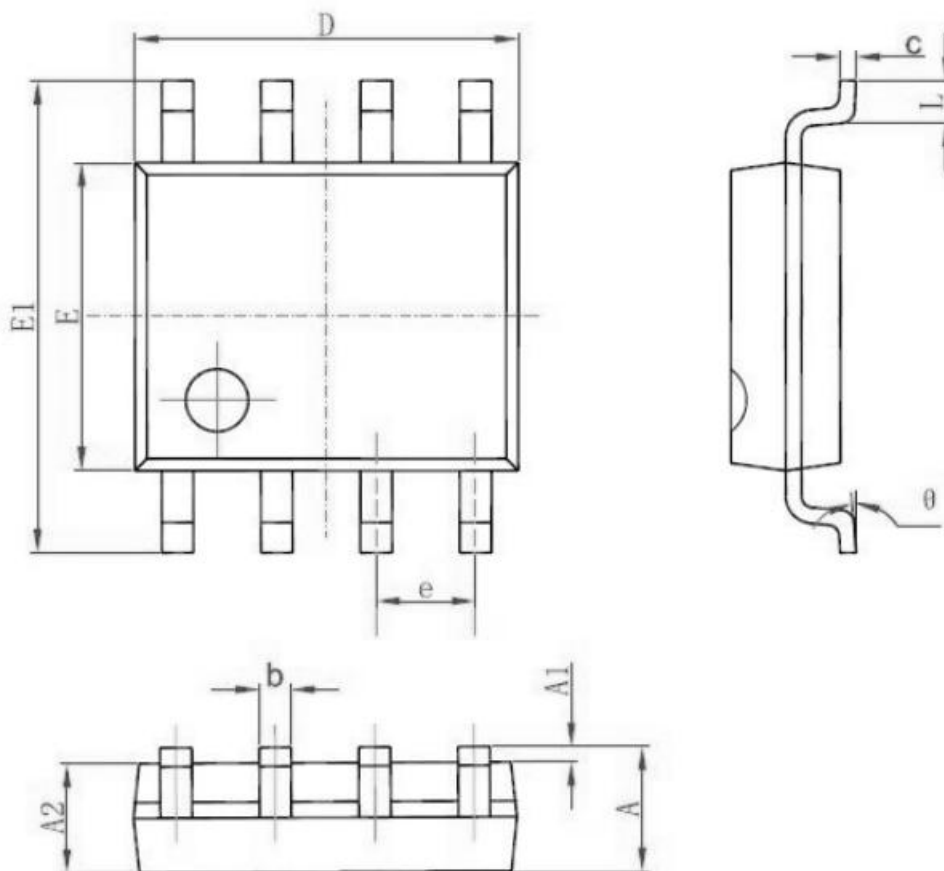


Figure 11: Transient Thermal Response Curve

■ Dimension 外形封装尺寸



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		0.050 (BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°